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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIDNAL
10/042,317 01/11/2002		Tosifumi Kojima	Q68073	CONFIRMATION NO.
75	00,04,2003			/
SUGHRUE MION, PLLC 2100 Pennsylvania Avenue, NW			EXAMINER	
Washington, DC 20037-3213			KEEHAN, CHRISTOPHER M	
			ART UNIT	PAPER NUMBER
			1712	(P)
			DATE MAILED: 06/04/2003	/ 1.

Please find below and/or attached an Office communication concerning this application or proceeding.

		Appli	cation No.	Applicant(s)		
			2,317			
	Office Action Summary	Exam		KOJIMA ET AL.		
			opher M. Keehan	Art Unit		
Period fo	The MAILING DATE of this community or Reply	nication appears or	the cover sheet with the	1712		
A SH THE	ORTENED STATUTORY PERIOD F MAILING DATE OF THIS COMMUN	FOR REPLY IS SE	T TO EXPIRE <u>3</u> MONTH	I(S) FROM		
after - If the - If NO - Failu - Any r	nsions of time may be available under the provision: SIX (6) MONTHS from the mailing date of this comperiod for reply specified above is less than thirty (3) period for reply is specified above, the maximum size to reply within the set or extended period for reply eply received by the Office later than three months and patent term adjustment. See 37 CFR 1.704(b).	s of 37 CFR 1.136(a). In n munication. 30) days, a reply within the tatutory period will apply a	statutory minimum of thirty (30) da	ays will be considered timely.		
1)🖂	Responsive to communication(s) fi	led on 11 January	2002	f		
2a)[_	Tt	2b)⊠ This action		•		
3)						
<i>,</i> —	Since this application is in condition closed in accordance with the pracon of Claims	tice under <i>Ex parte</i>	e Quayle, 1935 C.D. 11,	rosecution as to the merits is 453 O.G. 213.		
4)🛛	Claim(s) $1-9$ is/are pending in the a	pplication.				
	a) Of the above claim(s) is/a		consideration.			
5)	Claim(s) is/are allowed.					
6)🛛	Claim(s) <u>1-5 and 7-9</u> is/are rejected.					
	Claim(s) <u>6</u> is/are objected to.					
8) ∐ (8 Applicatio	Claim(s) are subject to restric	tion and/or electior	requirement.			
	he specification is objected to by the	Evaminor				
10)∐ T	he drawing(s) filed on is/are:					
	Applicant may not request that any obje	ection to the drawing	objected to by the Exam	miner.		
11) 🔲 TI	he proposed drawing correction filed	on is a	approved by	ee 37 CFR 1.85(a).		
	If approved, corrected drawings are req		approved b) disappro	ved by the Examiner.		
12) 🔲 TI	ne oath or declaration is objected to	by the Examiner	Office action.			
Priority un	der 35 U.S.C. §§ 119 and 120	ay are axammer.				
		for foreign priorites	Indox 25 II O O D Assess			
13)⊠ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a)⊠ All b)□ Some * c)□ None of:						
		looumonto hava ka				
Profits documents have been received.						
2. Certified copies of the priority documents have been received in Application No 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (DCT Buts 47.9).						
* Se	e the attached detailed Office action	for a list of the cer	i Rule 17.2(a)). tified copies not received	4		
14)∏ Acl	knowledgment is made of a claim for	domestic priority u	under 35 U.S.C. 8 119(e)	(to a provisional applications)		
α, ι	☐ The translation of the foreign lang knowledgment is made of a claim fol	Uage provisional a	polication has been as			
tachment(s		smooto priority (ander 30 U.S.C. 99 120	ang/or 121.		
Notice o	f References Cited (PTO-892)		4) Intension Summer	(DTO 440) B		
☐ Notice o	f Draftsperson's Patent Drawing Review (PT0 ion Disclosure Statement(s) (PTO-1449) Pap	O-948) er No(s) <u>5</u> .	5) Notice of Informal Pa	PTO-413) Paper No(s) stent Application (PTO-152)		
	mark Office 04-01)					

DETAILED ACTION

Examiner's Suggestions

The following are suggestions by the examiner to create a clearer prosecution record. These suggestions are not objections or rejections, but merely some things that might prove helpful upon consideration by applicant. In claim 8, the claim language "provided at least one side" is not clear. Perhaps "provided on at least one side" might help clarify the claim. Further, in claim 8, the claim language "the build-up layer" could probably be "built-up layer" as claimed previously in the claim. Claim 7, the claim language "a semiconductor disposed substantially above the electronic part" appears to read on a multitude of scenarios. In any modern electronic equipment there is bound to be a semiconductor located substantially above an electronic component, such as that of Kawamoto et al. Perhaps adding some structure to the claim would be helpful.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

Claims 1, 2, 4, 5, 8, and 9 are rejected under 35 U.S.C. 102(b) as being anticipated by Kawamoto et al. (JP 09096046, full English translation, attached). The examiner is relying on the full English translation of this JP document. Regarding claims 1 and 2, Kawamoto et al. disclose an embedding resin for embedding an

electronic part in a wiring substrate comprising at least one of a soluble resin and a soluble filler as a soluble component to be dissolved with an oxidizing agent (sections 0020 and 0030).

Regarding claim 4, Kawamoto et al. disclose a substrate having an opening, an electronic part disposed in the opening, and an embedding resin according to claim 1, wherein the gap between the substrate and the electronic part is filled with the embedding resin (Figures 1 and 2).

Regarding claim 5, Kawamoto et al. disclose a wiring, wherein the wiring is provided at least partly on the embedding resin, and the embedding resin is roughened at least on an interface thereof in contact with the wiring (section 0020, section 0029, and Figures 1 and 2).

Regarding claim 8, Kawamoto et al. disclose a core substrate and a built-up layer provided on at least one side of the core layer and formed by alternately laminating an insulating layer and a wiring layer (sections 0021-0026), wherein the core substrate and the built-up layer has the opening penetrating therethrough (Figures 1 and 2).

Regarding claim 9, Kawamoto et al. disclose the instantly claimed process steps (section 0012, section 0014, sections 0020 and 0030, and section 00029).

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

⁽e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States

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only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

Claims 1-5, 8, and 9 are rejected under 35 U.S.C. 102(e) as being anticipated by Nakamura et al. (6,376,053 B1). Nakamura et al. disclose an embedding resin comprising at least one soluble resin (col.4, line 58-col.5, line 24) and a soluble organic filler (col.7, lines 3-27) as a soluble component to be dissolved with an oxidizing agent col.10, lines 3-15).

Regarding claim 2, Nakamura et al. disclose at least one of a liquid epoxy resin (col.5, lines 25-64) and an inorganic filler (col.4, lines 32-48) as an undissolved component that is not substantially dissolved in the oxidizing agent.

Regarding claim 3, Nakamura et al. disclose a bisphenol epoxy resin (col.4, line 58-col.5, line 24).

Regarding claim 4, Nakamura et al. disclose a substrate comprising a substrate having an opening, an electronic part in the opening, and an embedding resin according to claim 1, wherein a gap between the substrate and the electronic part is filled with the embedding resin (Figure 1).

Regarding claim 5, Nakamura et al. disclose a wiring, wherein the wiring is provided at least partly on the resin, and the resin is roughened at least on an interface thereof in contact with the wiring (col.10, lines 3-15).

Regarding claim 8, Nakamura et al. disclose a core substrate and a built-up layer provided on at least one side of the core layer and formed by alternately laminating an insulating layer and a wiring layer, wherein the core substrate and the built-up layer has

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the opening penetrating therethrough (Figures 3 and 4, and col.8, line 58-col.10, line 32).

Regarding claim 9, Nakamura et al. disclose the instantly claimed process steps (col.8, line 58-col.10, line 32, and Figures 3 and 4).

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 7 is rejected under 35 U.S.C. 103(a) as being unpatentable over Kawamoto et al. (JP 09096046). Kawamoto et al., as applied to claim 1 above, are as set forth and incorporated herein. Kawamoto et al. do not appear to specifically disclose a semiconductor disposed substantially above the electronic part. Kawamoto et al. do disclose an outer wiring connection (Figure 2) and use of the invention in notebook computers (section 0005). Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made for a semiconductor to be connected to these outer wiring leads at some point substantially above the electronic component because semiconductors are prevalent in notebook computers and the wiring leads would have been connected to something, such as a semiconductor.

Allowable Subject Matter

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Claim 6 is objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims. A reasonable search of the prior art of record failed to reveal the limitations as set forth in claim 6, specifically an electrode with a roughened surface as instantly claimed. Kawamoto et al. disclose an outer wiring connection that can act as an electrode, but do not teach or disclose the instantly claimed roughened surface.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Christopher M. Keehan whose telephone number is (703) 305-2778. The examiner can normally be reached on Monday-Friday, from 6:30 to 3:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Robert A. Dawson can be reached on 308-2340. The fax phone numbers for the organization where this application or proceeding is assigned are (703) 872-9310 for regular communications and (703) 872-9311 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-0661.

Robert Dawson Supervisory Patent Examiner Technology Center 1700

Christopher Keehan (WW

April 29, 2003